



Optimization of Package Power Delivery and Power Removal Solutions to meet Platform level Challenges

Kaladhar Radhakrishnan

Michael J. Hill

Kemal Aygün

Chia-Pin Chiu

Gaurang Choksi

Agenda

- **Metrology for Platform Level Power Delivery Characterization**
- **New Power Delivery Architecture and Thermal Considerations for Multi-Core Servers**
- **Recent Advances in Package Power Delivery and Power Removal Solutions**

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